



SANDIP
UNIVERSITY
— UGC Recognised —

Sandip University, Nashik
School of Computer Science and Engineering (SOCSE)
Department of Computer Science and Engineering

Report of Expert Lecture/Workshop/Symposium/Conference/Industry Visit/Meeting

Category of Event (Expert	:	SEMINAR
Lecture/Workshop/Symposium/Confer		
ence/Industry Visit/Meeting/		
Conference)		
Title (Name of Event)	:	“IEEE Student Activities and Benefits for Employability Skills”
Schedule (Date(s) and Time)	:	09 Feb 2024 Time 2:30 PM to 3:30 PM
Venue	:	Seminar Hall, O Building
Duration	:	2 Hr
Organizing Faculty/ Convener (s)	:	Dr. Pankaj Dashore
Organizing Department	:	SOCSE
Faculty Coordinators	:	Dr. Pankaj Dashore
Total Number of Participants	:	105
Expert(s) Profile	:	Prof. Sandip Mishra K.J. Somaiya Institue of Technology, Sion Mumbai, IEEE SAC Subdivision Chair for Nashik Region.
Objectives	:	Showcase how participation in IEEE activities can

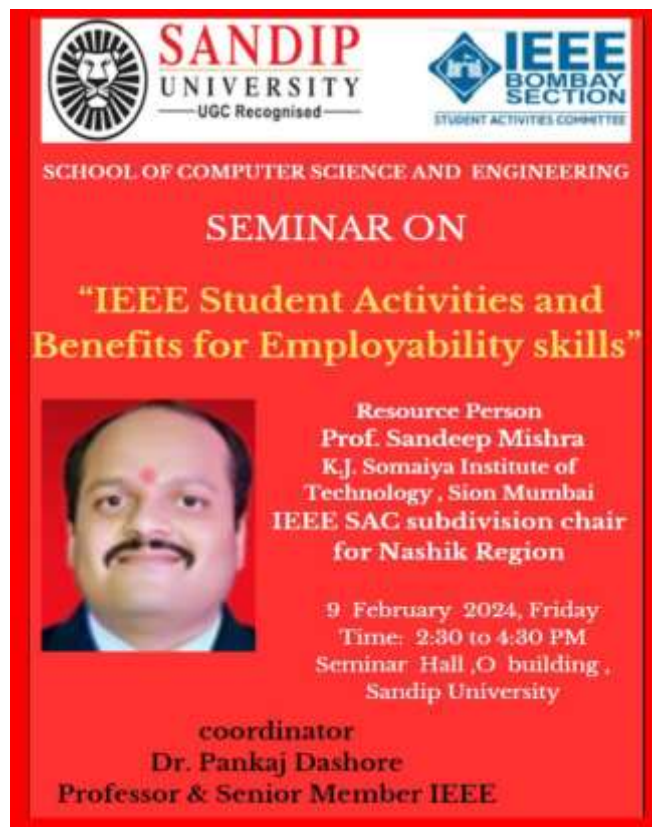
enhance students' employability skills, such as technical proficiency, teamwork, leadership, communication, and problem-solving abilities.

About the activity : One Day Seminar on IEEE Student Activities and Benefits for Employability skills. Jointly organized by School of Computer Science and Engineering, Sandip University Nashik and SAC, IEEE Bombay Section through real-world examples and success stories, the seminar will highlight how involvement in IEEE activities can significantly enhance students' employability skills. These skills include technical proficiency, problem-solving abilities, teamwork, leadership, communication, and project management. Participants will learn how to navigate these resources effectively to enhance their academic learning and advance their career goals.

Conclusion & Remarks :

Any other (as per requirements) :

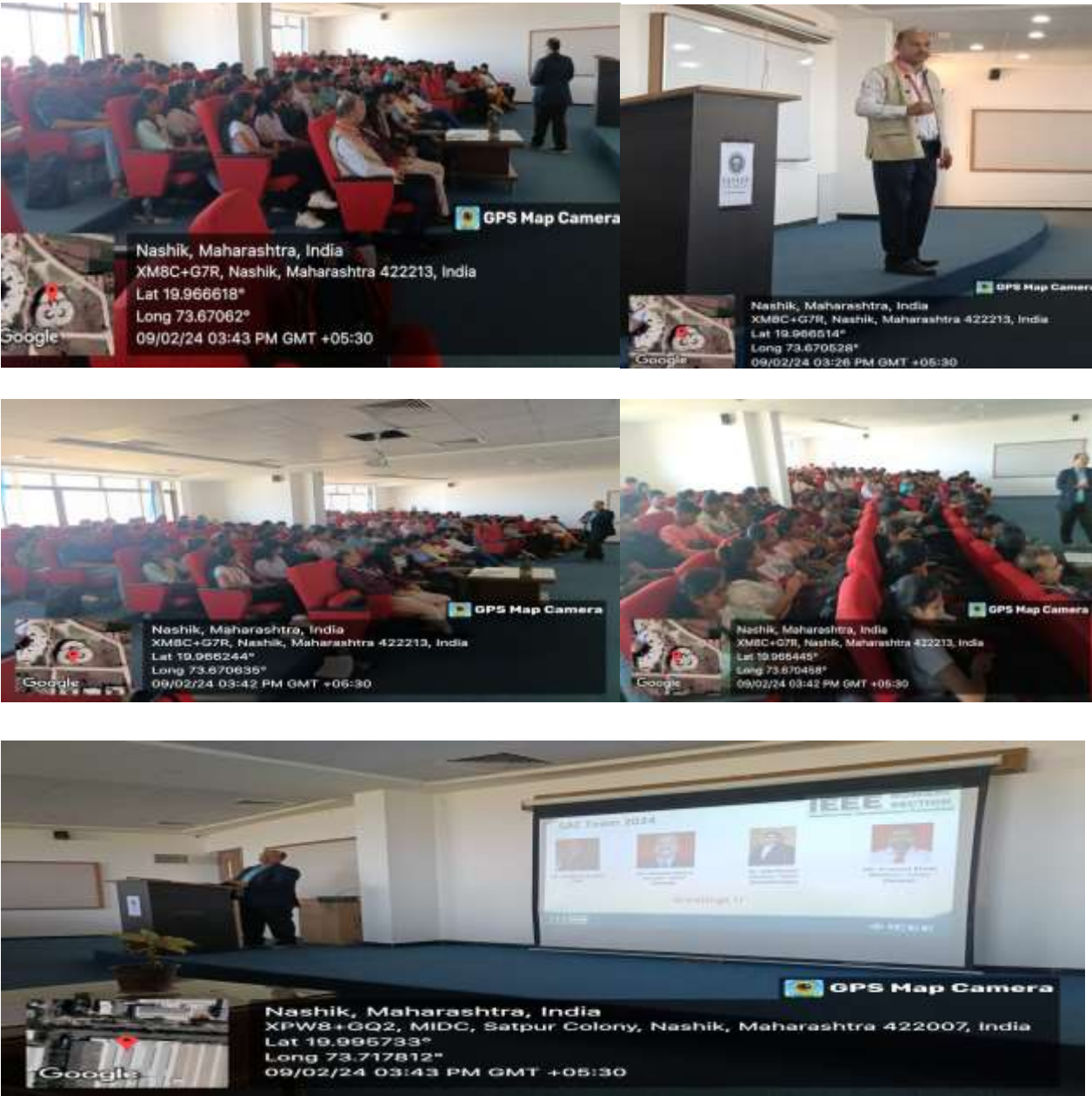
Flyer (If applicable) :



Itinerary (If applicable) :

Geotagged Photographs

:



News Coverage (If applicable) :

List of Participants: (attach detail list with Names and sign of participants)

Signature of Convener/Organizer

Signature of Head/Dean